

APPLICATION DATA SHEET**Application Information**

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence submission?::

Computer Readable Form (CRF)?:: No

Number of copies of CRF::

Title :: PUMPLESS MICROFLUIDICS

Attorney Docket Number:: 660115.411C2

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 9

Small Entity?:: Yes

Petition included?:: No

Petition Type::

Licensed U.S. Gov't Agency::

Contract or Grant No::

Secrecy Order in Parent Appl.?:: No

First Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	Austria
Status::	Full Capacity
Given Name::	Bernhard
Middle Name::	H
Family Name::	Weigl
Name Suffix::	
City of Residence::	Seattle
State or Province of Residence::	WA
Country of Residence::	US
Street of mailing address::	5530 Canfield Place North
City of mailing address::	Seattle
State or Province of mailing address::	WA
Country of mailing address::	US
Postal or Zip Code of mailing address::	98103

Second Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Clinton
Middle Name::	L
Family Name::	Williams
Name Suffix::	
City of Residence::	Tehachapi
State or Province of Residence::	CA
Country of Residence::	US
Street of mailing address::	630 Cherry Lane, Apartment H
City of mailing address::	Tehachapi
State or Province of mailing address::	CA
Country of mailing address::	US
Postal or Zip Code of mailing address::	93561

Third Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Jon
Middle Name::	W
Family Name::	Hayenga
Name Suffix::	
City of Residence::	Redmond
State or Province of Residence::	WA
Country of Residence::	US
Street of mailing address::	5310 240th Avenue Northeast
City of mailing address::	Redmond
State or Province of mailing address::	WA
Country of mailing address::	US
Postal or Zip Code of mailing address::	98052

Fourth Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Ronald
Middle Name::	L
Family Name::	Bardell
Name Suffix::	
City of Residence::	St. Louis Park
State or Province of Residence::	MN
Country of Residence::	US
Street of mailing address::	2333 Parkwoods Road
City of mailing address::	St. Louis Park
State or Province of mailing address::	MN
Country of mailing address::	US
Postal or Zip Code of mailing address::	66416

Fifth Applicant Information

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Thomas
Middle Name:: H
Family Name:: Schulte
Name Suffix::
City of Residence:: Redmond
State or Province of Residence:: WA
Country of Residence:: US
Street of mailing address:: 7830 235th Place Northeast
City of mailing address:: Redmond
State or Province of mailing address:: WA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 98053

Correspondence Information

Correspondence Customer Number :: **00500**

Representative Information

Representative Customer Number::		00500
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Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Continuation of	09/684,094	10/06/00
09/684,094	Continuation-in-Part of	09/415,404	10/08/99
09/684,094	Application claiming the benefit under 35 USC 119(e) of	60/213,865	06/23/00

Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::

Assignee Information

Assignee name::	Micronics, Inc.
Street of mailing address::	8463 154th Avenue Northeast
City of mailing address::	Redmond
State or Province of mailing address::	WA
Country of mailing address::	US
Postal or Zip Code of mailing address::	98052